

# PBSS4160DPN

60 V, 1 A NPN/PNP low  $V_{CEsat}$  (BISS) transistor

Rev. 01 — 3 June 2004

Objective data sheet

## 1. Product profile

### 1.1 General description

NPN/PNP low  $V_{CEsat}$  (BISS) transistor pair in a SOT457 (SC-74) plastic package.

### 1.2 Features

- Low collector-emitter saturation voltage  $V_{CEsat}$
- High collector current capability  $I_C$  and  $I_{CM}$
- High efficiency, reduces heat generation
- Reduces printed-circuit board area required.

### 1.3 Applications

- Power management
  - ◆ DC-to-DC conversion
  - ◆ Supply line switching
- Peripheral driver
  - ◆ Inductive load drivers (e.g. relays, buzzers and motors)
  - ◆ Driver in low supply voltage applications (e.g. lamps and LEDs).

### 1.4 Quick reference data

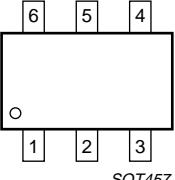
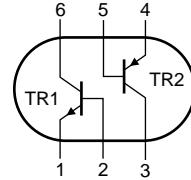
Table 1: Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
			NPN	PNP	Unit		
$V_{CEO}$	collector-emitter voltage		-	-	60	-60	V
$I_C$	collector current (DC)		-	-	1	-1	A
$I_{CRP}$	repetitive peak collector current		-	-	2	-1.5	A
$R_{CEsat}$	equivalent on-resistance		-	-	250	330	$m\Omega$

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## 2. Pinning information

Table 2: Discrete pinning

Pin	Description	Simplified outline	Symbol
1, 4	emitter TR1; TR2		
2, 5	base TR1; TR2		
6, 3	collector TR1; TR2	 SOT457	 sym019

## 3. Ordering information

Table 3: Ordering information

Type number	Package			Version
	Name	Description		
PBSS4160DPN	-	plastic surface mounted package; 6 leads		SOT457

## 4. Marking

Table 4: Marking

Type number	Marking code [1]
PBSS4160DPN	B4

[1] Made in Malaysia.

## 5. Limiting values

**Table 5: Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
<b>Per transistor unless otherwise specified; for the PNP transistor with negative polarity</b>					
$V_{CBO}$	collector-base voltage	open emitter	-	80	V
$V_{CEO}$	collector-emitter voltage	open base	-	60	V
$V_{EBO}$	emitter-base voltage	open collector	-	5	V
$I_C$	collector current (DC)		-	1	A
$I_{CM}$	peak collector current	$t = 1 \text{ ms or limited by } T_{j(\max)}$	-	2	A
$I_{CRP}$	repetitive peak collector current				
	NPN		[1]	-	A
	PNP		[1]	-	A
$I_B$	base current (DC)		-	300	mA
$I_{BM}$	peak base current	$t_p \leq 300 \mu\text{s}; \delta \leq 0.02$	-	1	A
$P_{tot}$	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$	[2]	-	mW
			[3]	-	mW
			[1]	-	W
$T_j$	junction temperature		-	150	$^\circ\text{C}$
$T_{amb}$	operating ambient temperature		-65	+150	$^\circ\text{C}$
$T_{stg}$	storage temperature		-65	+150	$^\circ\text{C}$
<b>Per device</b>					
$P_{tot}$	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$	[3]	-	mW

[1] Device mounted on a ceramic circuit board,  $\text{Al}_2\text{O}_3$ , standard footprint.

[2] Device mounted on a FR4 printed-circuit board, single-sided copper, tin-plated, standard footprint.

[3] Device mounted on a FR4 printed-circuit board, single-sided copper, tin-plated, mounting pad for collector  $1 \text{ cm}^2$ .

## 6. Thermal characteristics

**Table 6: Thermal characteristics**

Symbol	Parameter	Conditions	Typ	Unit
<b>Per transistor</b>				
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] 340	K/W
			[2] 110	K/W

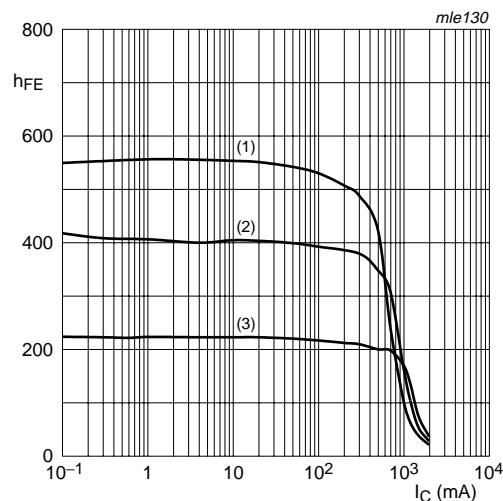
[1] Device mounted on a FR4 printed-circuit board, single-sided copper, tin-plated, mounting pad for collector  $1 \text{ cm}^2$ .[2] Device mounted on a ceramic circuit board,  $\text{Al}_2\text{O}_3$ , standard footprint.

## 7. Characteristics

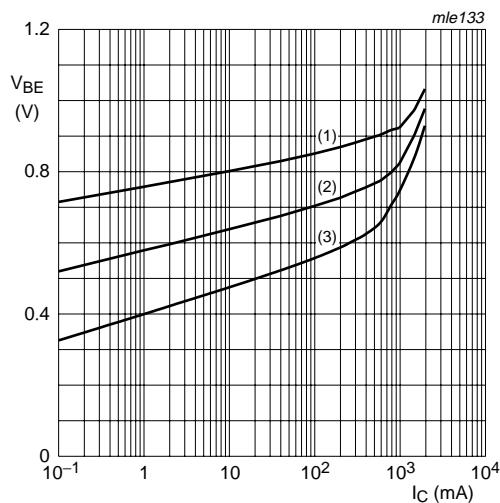
**Table 7: Characteristics** $T_j = 25^\circ\text{C}$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Per transistor unless otherwise specified; for the PNP transistor with negative polarity</b>						
$I_{CBO}$	collector-base cut-off current	$V_{CB} = 60 \text{ V}; I_E = 0 \text{ A}$	-	-	100	nA
		$V_{CB} = 60 \text{ V}; I_E = 0 \text{ A}; T_j = 150^\circ\text{C}$	-	-	50	µA
$I_{CES}$	collector-emitter cut-off current	$V_{CE} = 60 \text{ V}; V_{BE} = 0 \text{ V}$	-	-	100	nA
$I_{EBO}$	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_C = 0 \text{ A}$	-	-	100	nA
$V_{BEsat}$	base-emitter saturation voltage	$I_C = 1 \text{ A}; I_B = 50 \text{ mA}$	-	0.95	1.1	V
$V_{BEon}$	base-emitter turn-on voltage	$V_{CE} = 5 \text{ V}; I_C = 1 \text{ A}$	-	0.82	0.9	V
$f_T$	transition frequency	$I_C = 50 \text{ mA}; V_{CE} = 10 \text{ V}; f = 100 \text{ MHz}$	150	220	-	MHz
<b>TR1 (NPN)</b>						
$h_{FE}$	DC current gain	$V_{CE} = 5 \text{ V}; I_C = 1 \text{ mA}$	250	400	-	
		$V_{CE} = 5 \text{ V}; I_C = 500 \text{ mA}$	[1]	200	350	
		$V_{CE} = 5 \text{ V}; I_C = 1 \text{ A}$	[1]	100	150	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = 100 \text{ mA}; I_B = 1 \text{ mA}$	-	90	110	mV
		$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}$	-	110	140	mV
		$I_C = 1 \text{ A}; I_B = 100 \text{ mA}$	[1]	-	200	mV
$R_{CEsat}$	equivalent on-resistance	$I_C = 1 \text{ A}; I_B = 100 \text{ mA}$	[1]	-	200	250
$C_c$	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0 \text{ A}; f = 1 \text{ MHz}$	-	5.5	10	pF
<b>TR2 (PNP)</b>						
$h_{FE}$	DC current gain	$V_{CE} = -5 \text{ V}; I_C = -1 \text{ mA}$	200	350	-	
		$V_{CE} = -5 \text{ V}; I_C = -500 \text{ mA}$	[1]	150	250	
		$V_{CE} = -5 \text{ V}; I_C = -1 \text{ A}$	[1]	100	160	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = -100 \text{ mA}; I_B = -1 \text{ mA}$	-	-110	-160	mV
		$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	-	-120	-175	mV
		$I_C = -1 \text{ A}; I_B = -100 \text{ mA}$	[1]	-	-220	mV
$R_{CEsat}$	equivalent on-resistance	$I_C = -1 \text{ A}; I_B = -100 \text{ mA}$	[1]	-	220	330
$C_c$	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = I_e = 0 \text{ A}; f = 1 \text{ MHz}$	-	9	15	pF

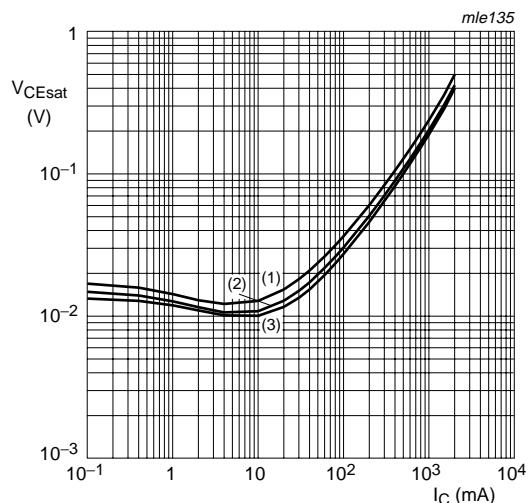
[1] Pulse test:  $t_p \leq 300 \mu\text{s}; \delta \leq 0.02$ .

**TR1 (NPN)** $V_{CE} = 5$  V.

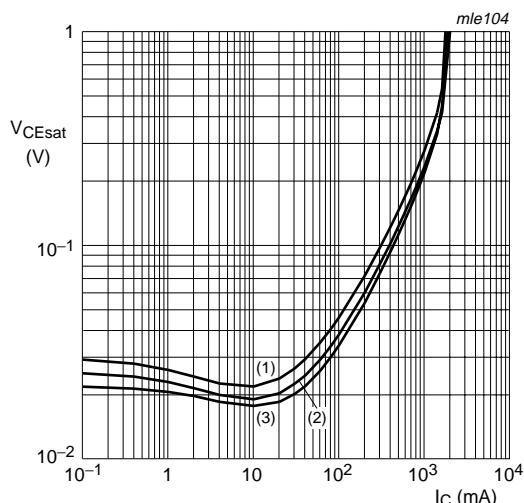
- (1)  $T_{amb} = 100$  °C.
- (2)  $T_{amb} = 25$  °C.
- (3)  $T_{amb} = -55$  °C.

**Fig 1.** DC current gain as a function of collector current; typical values.**TR1 (NPN)** $V_{CE} = 5$  V.

- (1)  $T_{amb} = -55$  °C.
- (2)  $T_{amb} = 25$  °C.
- (3)  $T_{amb} = 100$  °C.

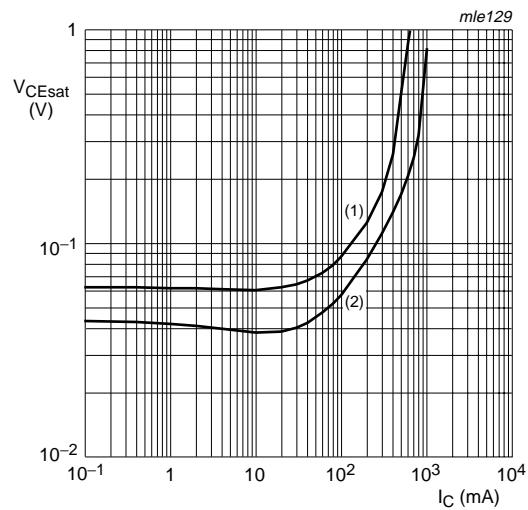
**Fig 2.** Base-emitter voltage as a function of collector current; typical values.**TR1 (NPN)** $I_C/I_B = 10$ .

- (1)  $T_{amb} = 100$  °C.
- (2)  $T_{amb} = 25$  °C.
- (3)  $T_{amb} = -55$  °C.

**Fig 3.** Collector-emitter saturation voltage as a function of collector current; typical values.**TR1 (NPN)** $I_C/I_B = 20$ .

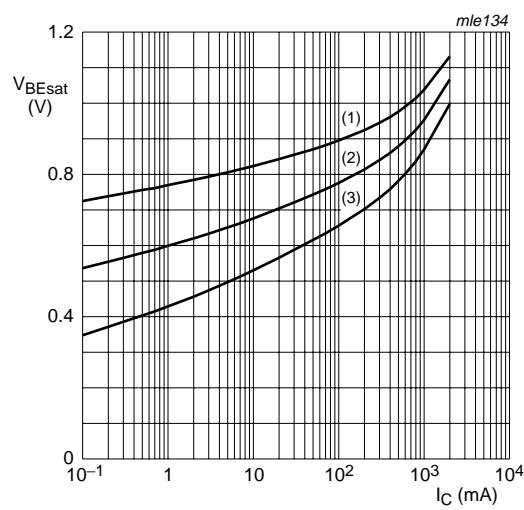
- (1)  $T_{amb} = 100$  °C.
- (2)  $T_{amb} = 25$  °C.
- (3)  $T_{amb} = -55$  °C.

**Fig 4.** Collector-emitter saturation voltage as a function of collector current; typical values.

**TR1 (NPN)** $T_{amb} = 25 \text{ }^\circ\text{C}$ .

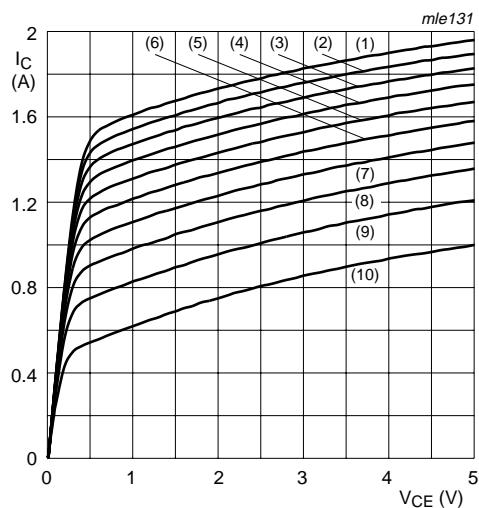
- (1)  $I_C/I_B = 100$ .
- (2)  $I_C/I_B = 50$ .

**Fig 5.** Collector-emitter saturation voltage as a function of collector current; typical values.

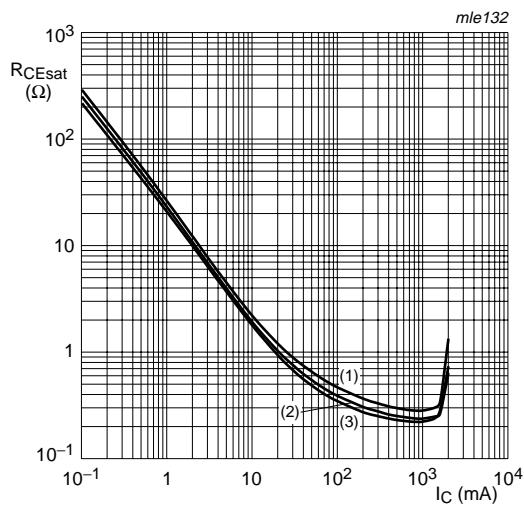
**TR1 (NPN)** $I_C/I_B = 20$ .

- (1)  $T_{amb} = -55 \text{ }^\circ\text{C}$ .
- (2)  $T_{amb} = 25 \text{ }^\circ\text{C}$ .
- (3)  $T_{amb} = 100 \text{ }^\circ\text{C}$ .

**Fig 6.** Base-emitter saturation voltage as a function of collector current; typical values.

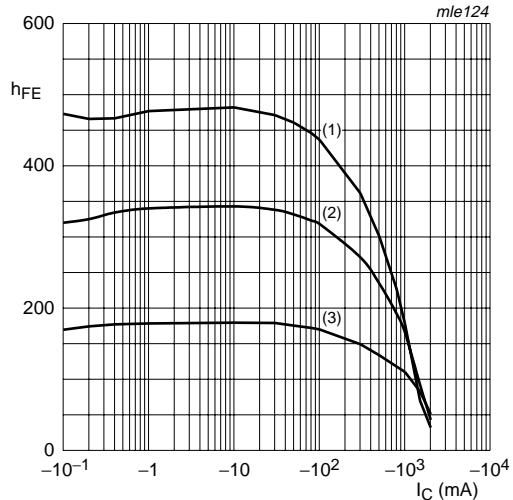
**TR1 (NPN)** $T_{amb} = 25 \text{ }^{\circ}\text{C}$ .

- (1)  $I_B = 60 \text{ mA}$ .
- (2)  $I_B = 54 \text{ mA}$ .
- (3)  $I_B = 48 \text{ mA}$ .
- (4)  $I_B = 42 \text{ mA}$ .
- (5)  $I_B = 36 \text{ mA}$ .
- (6)  $I_B = 30 \text{ mA}$ .
- (7)  $I_B = 24 \text{ mA}$ .
- (8)  $I_B = 18 \text{ mA}$ .
- (9)  $I_B = 12 \text{ mA}$ .
- (10)  $I_B = 6 \text{ mA}$ .

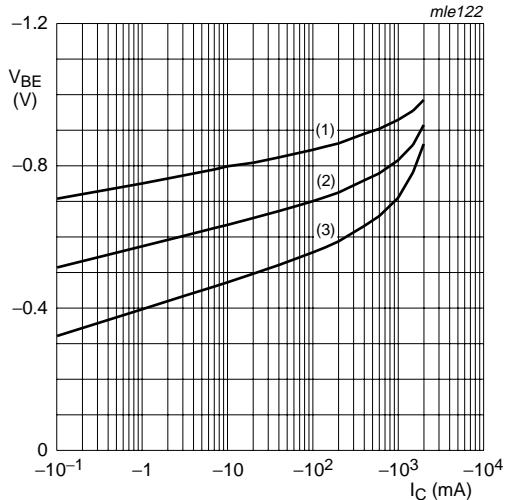
**Fig 7.** Collector current as a function of collector-emitter voltage; typical values.**TR1 (NPN)** $I_C/I_B = 20$ .

- (1)  $T_{amb} = 100 \text{ }^{\circ}\text{C}$ .
- (2)  $T_{amb} = 25 \text{ }^{\circ}\text{C}$ .
- (3)  $T_{amb} = -55 \text{ }^{\circ}\text{C}$ .

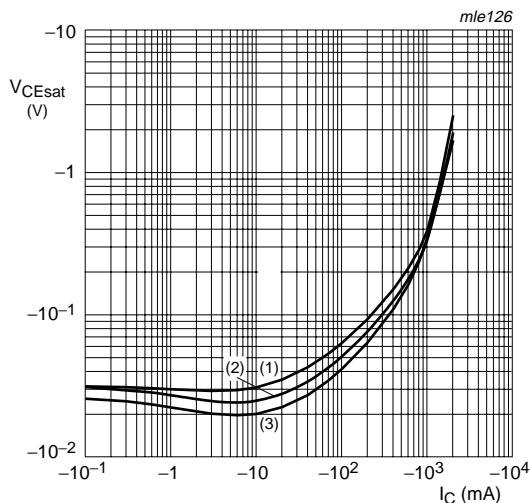
**Fig 8.** Collector-emitter equivalent on-resistance as a function of collector current; typical values.

**TR2 (PNP)** $V_{CE} = -5$  V.

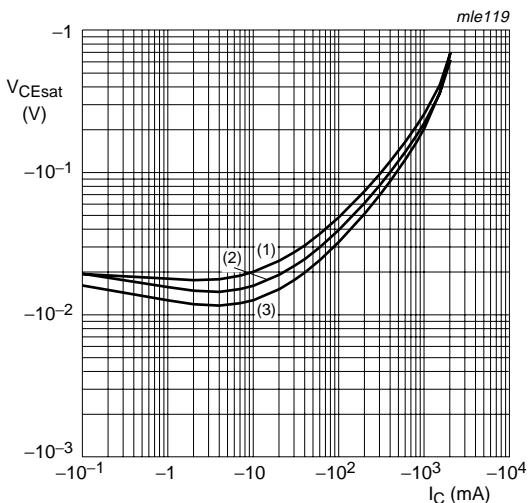
- (1)  $T_{amb} = 100$  °C.
- (2)  $T_{amb} = 25$  °C.
- (3)  $T_{amb} = -55$  °C.

**Fig 9.** DC current gain as a function of collector current; typical values.**TR2 (PNP)** $V_{CE} = -5$  V.

- (1)  $T_{amb} = -55$  °C.
- (2)  $T_{amb} = 25$  °C.
- (3)  $T_{amb} = 100$  °C.

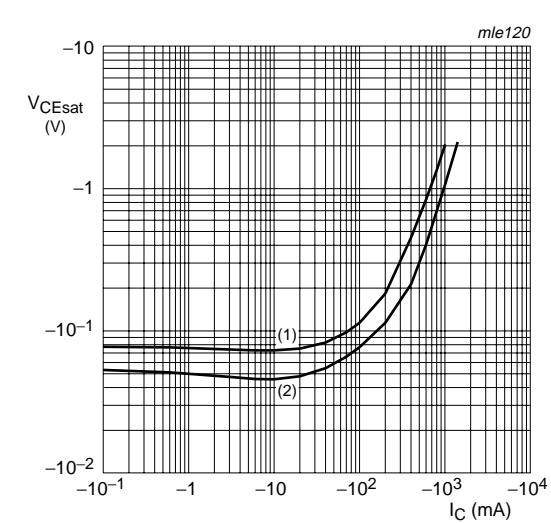
**Fig 10.** Base-emitter voltage as a function of collector current; typical values.**TR2 (PNP)** $I_C/I_B = 20$ .

- (1)  $T_{amb} = 100$  °C.
- (2)  $T_{amb} = 25$  °C.
- (3)  $T_{amb} = -55$  °C.

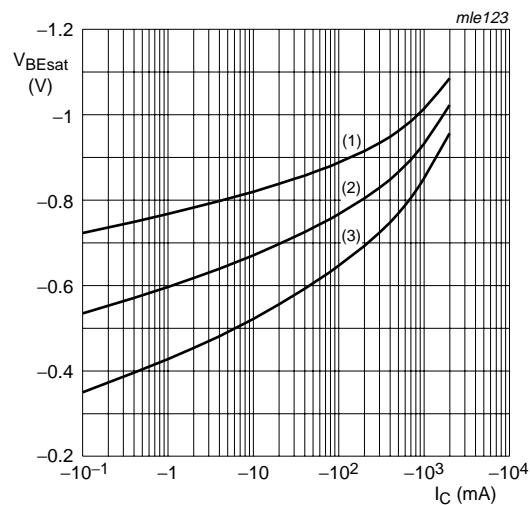
**Fig 11.** Collector-emitter saturation voltage as a function of collector current; typical values.**TR2 (PNP)** $I_C/I_B = 10$ .

- (1)  $T_{amb} = 100$  °C.
- (2)  $T_{amb} = 25$  °C.
- (3)  $T_{amb} = -55$  °C.

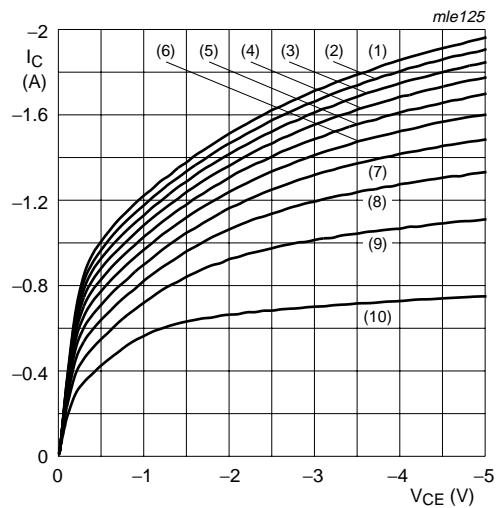
**Fig 12.** Collector-emitter saturation voltage as a function of collector current; typical values.



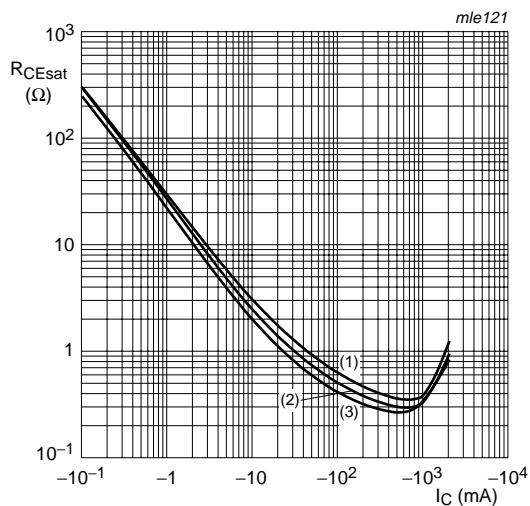
**Fig 13.** Collector-emitter saturation voltage as a function of collector current; typical values.



**Fig 14.** Base-emitter saturation voltage as a function of collector current; typical values.

**TR2 (PNP)** $T_{amb} = 25 \text{ }^{\circ}\text{C}$ .

- (1)  $I_B = -40 \text{ mA}$ .
- (2)  $I_B = -36 \text{ mA}$ .
- (3)  $I_B = -32 \text{ mA}$ .
- (4)  $I_B = -28 \text{ mA}$ .
- (5)  $I_B = -24 \text{ mA}$ .
- (6)  $I_B = -20 \text{ mA}$ .
- (7)  $I_B = -16 \text{ mA}$ .
- (8)  $I_B = -12 \text{ mA}$ .
- (9)  $I_B = -8 \text{ mA}$ .
- (10)  $I_B = -4 \text{ mA}$ .

**Fig 15.** Collector current as a function of collector-emitter voltage; typical values.**TR2 (PNP)** $I_C/I_B = 20$ .

- (1)  $T_{amb} = 100 \text{ }^{\circ}\text{C}$ .
- (2)  $T_{amb} = 25 \text{ }^{\circ}\text{C}$ .
- (3)  $T_{amb} = -55 \text{ }^{\circ}\text{C}$ .

**Fig 16.** Collector-emitter equivalent on-resistance as a function of collector current; typical values.

## 8. Package outline

Plastic surface mounted package; 6 leads

SOT457

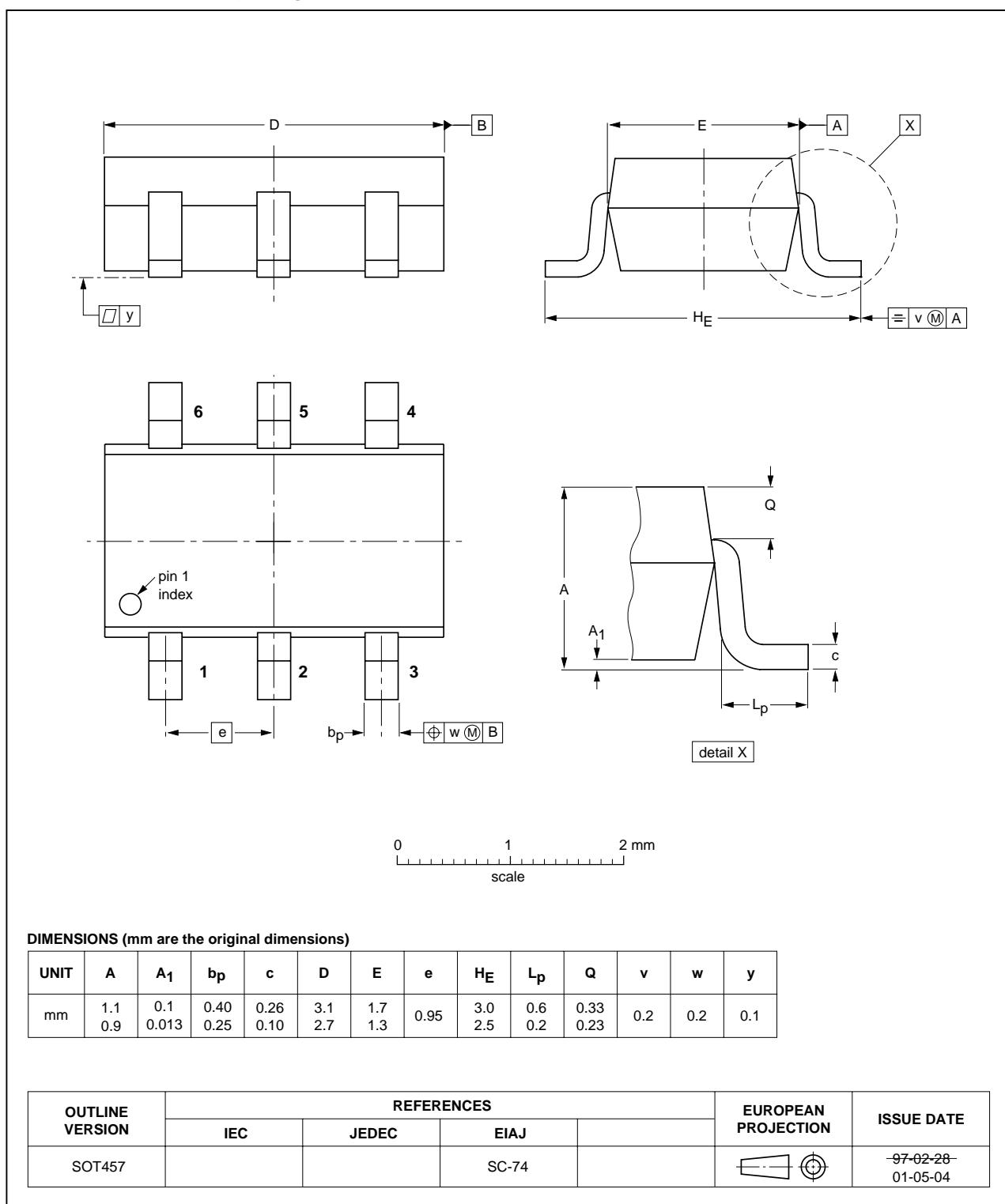


Fig 17. Package outline.



## 9. Revision history

Table 8: Revision history

Document ID	Release date	Data sheet status	Change notice	Order number	Supersedes
PBSS4160DPN_1	20040603	Objective data	-	9397 750 12701	-

## 10. Data sheet status

Level	Data sheet status [1]	Product status [2][3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

## 11. Definitions

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

**Limiting values definition** — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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For sales office addresses, send an email to: [sales.addresses@www.semiconductors.philips.com](mailto:sales.addresses@www.semiconductors.philips.com)



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Date of release: 3 June 2004  
Document order number: 9397 750 12701

Published in The Netherlands

